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CD4093B Types

CMOS **Quad 2-Input NAND Schmitt Triggers**

High-Voltage Types (20 Volt Rating)

CD4093B consists of four Schmitttrigger circuits. Each circuit functions as a two-input NAND gate with Schmitt-trigger action on both inputs. The gate switches at different points for positive- and negativegoing signals. The difference between the positive voltage (Vp) and the negative voltage (V_N) is defined as hysteresis voltage (V_H) (see Fig. 2).

The CD4093B types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

MAXIMUM RATINGS, Absolute-Maximum Values: DC SUPPLY-VOLTAGE RANGE, (VDD)

PACKAGE THERMAL IMPEDANCE, θ_{JA} (See Note 1):

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

E package

NS package

V_{DD}

٧'n

VSS

DC INPUT CURRENT, ANY ONE INPUT

M package

Features:

- Schmitt-trigger action on each input with no external components
- Hysteresis voltage typically 0.9 V at V_{DD} = 5 V and 2.3 V at V_{DD} = 10 V
- Noise immunity greater than 50%.
- No limit on input rise and fall times
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 µA at 18 V over full package-temperature range, 100 nA at 18 V and 25°C
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

.....±10mA

T

c) Test setuc

92CM-23882R

80°C/W

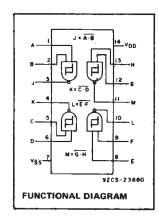
86°C/W

.. 76°C/W

Applications:

- Wave and pulse shapers
- High-noise-environment systems
- Monostable multivibrators
- Astable multivibrators
- INAND logic

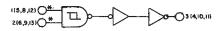
Voltages referenced to V_{SS} Terminal)-0.5V to +20V



RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	MIN.	MAX.	UNITS
Supply Voltage Range (T _A = Full Package			
Temp. Range)	3	18	V



ALL INPUTS PROTECTED BY PROTECTION NETWORK

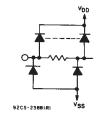
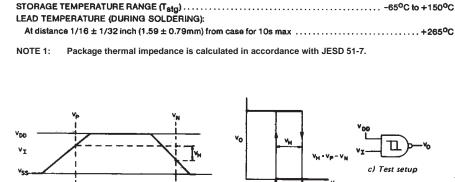


Fig. 1 - Logic diagram-1 of 4 Schmitt triggers.



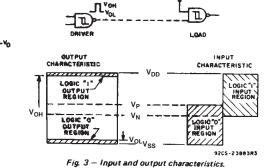


Fig. 2 – Hysteresis definition, characteristic, and test setup.

b) Transfer characteristic

of 1 of 4 gates.

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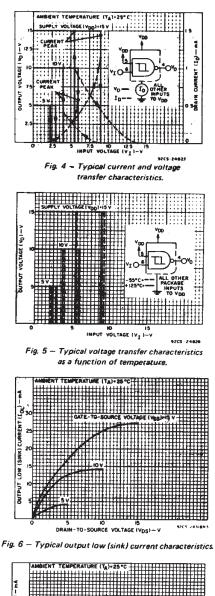
a) Definition of Vp. VN. VH



CD4093B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER- ISTIC		CONDITIONS LIMITS AT INDICATED TEMPERAT							ATURES	(°C)	UNIT
	٧o	VIN	VDD	1997 - 1997 1997 - 1997					+25]
	(V)	. (V)	(V)	55	-40	+85	+125	MIN.	TYP.	MAX.	
Quiescent Device	-	0,5	5	[1	· 1	30	- 30		0.02	1	
Current, IDD	_	0,10	10	2	2	60	60	-	0.02	2	μΑ
Max:		0,15	15	4	4	120	120	-	0.02	-4	1
	· · · · ·	0,20	20	20	20	600	600	. .	.0.04	20]
Positive Trigger		а	5	2.2	2.2	2.2	2.2	. 2.2	2.9		
Threshold Voltage	-	· a	· 10	4.6	4.6	4.6	4.6	4.6	. 5.9		
Vp Min.	-	а	15	6.8	6.8	. 6.8	6.8	6.8	8.8		
	-	b	5	2.6	2.6	2.6	2.6	2.6	3.3	-	V
	-	b.	10	5.6	5.6	5.6	5.6	_ 5.6	7.	-	1
	-	b	15	6.3	6.3	6.3	6.3	6.3	9.4	-	1
Vp Max.	·	а	5	3.6	3.6	3.6	3.6	-	2.9	3.6	
		a	10	7.1	7.1	7.1	.7.1		5.9	7.1	1
		a	15	10.8	10.8	10.8	10.8		8.8	10.8	
	-	b.	5	4	4	4	4	_	3.3	4	ľ
	_	b	10	8.2	8.2	8.2	8.2	_	7	8.2	1
		b	15	12.7	12.7	12.7	12.7	-	9.4	12.7	1
Negative Trigger	.—	а	5	0.9	0.9	0.9	0.9	0.9	1.9	-	
Threshold Voltage	;—	а	10	2.5	2.5	2.5	2.5	2.5	3.9	-	
V _N Min.		а	15	4	4	4	4	4	5.8	~ .	v
	-	b	5	1.4	1.4	1.4	1,4	1.4	2.3		
	_	b	10	3.4	3.4	3.4	3.4	3.4	5.1		
	-	b	15	4.8	4.8	4.8	4.8	4.8	7,3		
V _N Max.	-	а	5	2.8	2.8	2.8	2.8		1.9	2.8	• • • • • •
N max.	-	a	10	5.2	5.2	5.2	5.2	_	3.9	5.2	
1	-	a	15	7.4	7.4	7.4	7.4	-	5.8	7.4	
		b	5	3.2	3.2	3.2	3.2	 	2.3	3.2	V
		Ъ	10	6.6	6.6	6.6	6.6		5.1	6.6	
ł	-	b	15	9.6	9.6	9.6	9.6		7.3	9.6	
Hysteresis Voltage	-	a	5	0.3	0.3	0.3	0.3	0.3	0.9	-	
V _H Min.	-	a	10	1.2	1.2	1.2	1.2	1.2	2.3	-	
	-	а	15	1.6	1.6	1.6	1.6	1.6	3.5	_	
ł		ь	5	0.3	0.3	0.3	0.3	0.3	0.9		V
	-	ь	10	1.2	1.2	1.2	1.2	1.2	2.3	_	
-		ь	15	1.6	1.6	1.6	1.6	1.6	3.5	_	
VII Max	_	a	5	1.6	1.6	1,6	1.6		0.9	1.6	
V _H Max.		a	10	3.4	3.4	3.4	3.4	-	2.3	3.4	
-	-	a	15	5	5	5	5		3.5	5	
-		Ъ	5	1.6	1.6	1.6	1.6		0.9	1.6	V
	<u> </u>	Ъ	10	3.4	3.4	3.4	3.4		2.3	3.4	
-	<u>.</u>	-b :	15	5	5	5	- 5	- 7.	3,5	5	



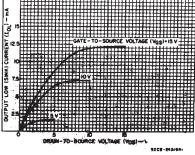


Fig 7 - Minimum output low (sink) current characteristics.

Input on terminals 1,5,8,12 or 2,6,9,13; other inputs to V_{DD}.

b Input on terminals 1 and 2, 5 and 6,8 and 9, or 12 and 13; other inputs to VDD-

STATIC ELECTRICAL CHARACTERISTICS (CONT'D)

CHARACTER- ISTIC	со	NDITI	ONS	LIMITS AT INDICATED TEMPERATURES (°C)							
	Vo.	VIN	VDD			<u> </u>	[·	+25			1
	(V)	(V)	.(V)	55	40	+85	+125	MIN.	TYP.	MAX.	1
Output Low (Sink)	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	-	· · · ·
Current,	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	-	
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	- 1	mA
Output High (Source) Current, IOH Min.	4.6	0,5	5	-0.64	-0.61	0.42	-0.36	-0.51	-1	-	
	2.5	0,5	5	<u>,</u> –2	-1.8	-1.3	-1.15	-1.6	-3.2	-	
	9.5	0,10	10	- 1.6	-1.5	-1.1	-0.9	-1.3	-2.6		
	13.5	0,15	15	-4.2	4	-2.8	-2.4	-3.4	6.8	. –	
Output Voltage	-	0,5	5		-	0.05		- ·	0	0.05	:
Low Level,	-	0,10	10			0.05		. –	. 0	0.05	
VOL Max.	i	0,15	15		. (0.05		, - -	0	0.05	v
Output Voltage	1	0,5	5	4.95 4.95 5 -						-	-
High-Level, V _{OH} Min.	. 1	0,10	10		•	9.95		9.95	10	- 1	
	-	0,15	15		14	4.95		14.95		_	
Input Current, I _{IN} Max.	-	0,18	18	±0.1	±0.1	±1	±1	-	±10-5	±0.1	μA

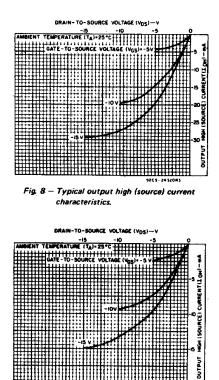


Fig. 9 – Minimum output high (source) current



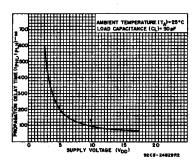
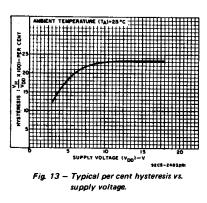


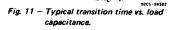
Fig. 10 - Typical propagation delay time vs. supply voltage.



DYNAMIC ELECTRICAL CHARACTERISTICS At $T_A = 25^{\circ}C$; Input t_r , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200k\Omega$

CHARACTERISTIC	TEST CONDI	TIONS	LIN			
CHARACTERISTIC		V _{DD} VOLTS	TYP. MAX.		UNITS	
Propagation Delay Time:		5	190	380		
^t PHL [,]		10	90	180	ns	
tPLH		15	65	130		
		5	100	200	1	
Transition Time, THL		10	50	100	ns	
ttlH		15	40	80		
Input Capacitance, CIN	Any Input		5	7.5	pF.	

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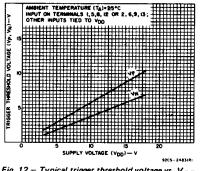
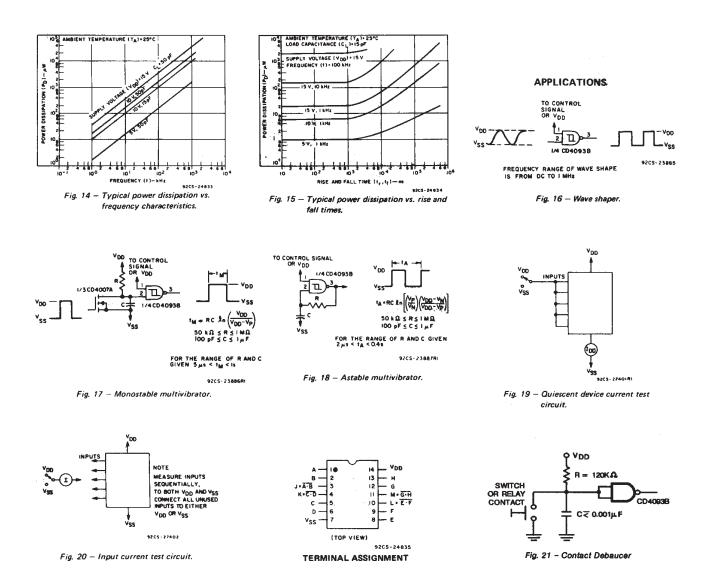


Fig. 12 – Typical trigger threshold voltage vs. V_{DD}

CD4093B Types



26-Sep-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
7704602CA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
CD4093BE	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4093BEE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4093BF	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
CD4093BF3A	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
CD4093BM	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BM96	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BM96E4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BM96G4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BME4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BMT	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BMTE4	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4093BPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder



PACKAGE OPTION ADDENDUM

26-Sep-2005

temperature.

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J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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